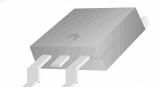


FJD3076

Power Amplifier Applications

Low Collector-Emitter Saturation Voltage



D-PACK

1. Base 2. Collector 3. Emitter

NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	40	V
V _{CEO}	Collector-Emitter Voltage	32	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current	2	А
P _C	Collector Dissipation (T _a =25°C)	1	W
	Collector Dissipation (T _C =25°C)	10	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 55 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 1mA$, $I_B = 0$	32			V
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = 50\mu A$	40			V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 50\mu A$	5			V
I _{CBO}	Collector Cut-off Current	$V_{CB} = 20V, I_{E} = 0$			1	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 4V, I_{C} = 0$			1	μΑ
h _{FE}	DC Current Gain	$V_{CE} = 3V, I_{C} = 0.5A$	130		390	-1 17
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = 2A, I_B = 0.2A$		0.5	0.8	V
f _T	Current Gain Bandwidth Product	$V_{CE} = 5V, I_{E} = -0.5A,$ f = 100MHz	EF	100	075	MHz
C _{ob}	Output Capacitance	$V_{CB} = 10V, I_E = 0A,$ f = 1MHz		50		pF

Typical Characteristics

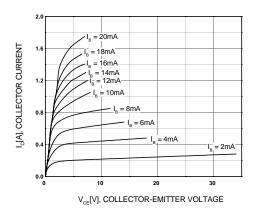


Figure 1. Static Characteristic

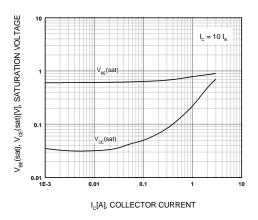


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

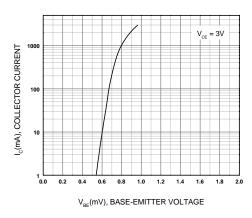


Figure 5. Base-Emitter On Voltage

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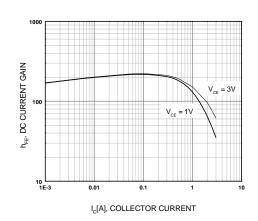


Figure 2. DC Current Gain

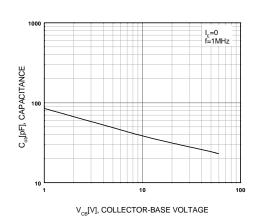


Figure 4. Collector Output Capacitance

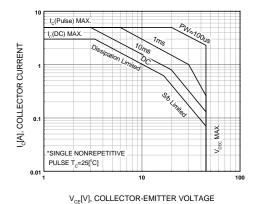
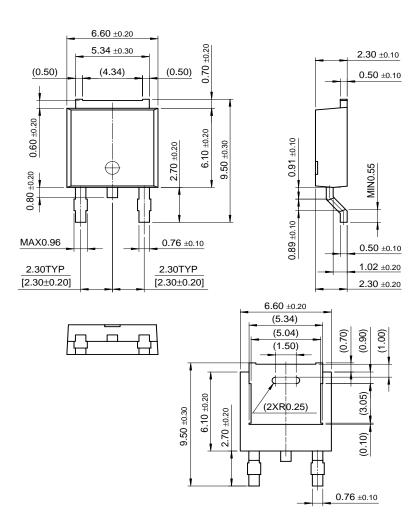


Figure 6. Safe Operating Area

Rev. C1, December 2001

Package Demensions

D-PAK



Dimensions in Millimeters

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